

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

EPAS ID: PAT7714182

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
HAVI GLOBAL SOLUTIONS, LLC	12/13/2022
RECEIVING PARTY DATA	
Name:	HOOWAKI, LLC
Street Address:	400 BIRNIE ST.
Internal Address:	SUITE C
City:	GREENVILLE
State/Country:	SOUTH CAROLINA
Postal Code:	29611
PROPERTY NUMBERS Total: 4	
Property Type	Number
Application Number:	15424627
Application Number:	15971687
Application Number:	15631892
Application Number:	15481290
CORRESPONDENCE DATA	
Fax Number:	(864)286-3282
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	8649736688
Email:	doug@kimandlahey.com
Correspondent Name:	KIM AND LAHEY LAW FIRM, LLC
Address Line 1:	3620 PELHAM RD. PBM #213
Address Line 4:	GREENVILLE, SOUTH CAROLINA 29615
ATTORNEY DOCKET NUMBER:	051528
NAME OF SUBMITTER:	DOUGLAS W. KIM
SIGNATURE:	/Douglas W. Kim (44828)/
DATE SIGNED:	12/27/2022
Total Attachments: 6	
source=HoowakiHAVIAssignment#page1.tif	

source=HoowakiHAVIAssignment#page2.tif
source=HoowakiHAVIAssignment#page3.tif
source=HoowakiHAVIAssignment#page4.tif
source=HoowakiHAVIAssignment#page5.tif
source=HoowakiHAVIAssignment#page6.tif

Exhibit B

ASSIGNMENT OF PATENT RIGHTS

For good and valuable consideration, the receipt of which is hereby acknowledged, Havi Global Solutions, LLC a Delaware limited liability company, currently with an office at 3500 Lacey Road Suite 600, Downers Grove, IL 60515, ("**Assignor**"), does hereby sell, assign, transfer, and convey unto Hoowaki, LLC, a South Carolina limited liability company, with an office at 400 Birnie Street, Suite C, Greenville, SC 29611 ("**Assignee**"), or its designees, all right, title, and interest that exist today and may exist in the future in and to any and all of the following (collectively, the "**Patent Rights**");

- (a) the patent applications and patents listed in the table below (the "**Patents**");
- (b) all patents and patent applications (i) to which any of the Patents directly or indirectly claims priority, and/or (ii) for which any of the Patents directly or indirectly forms a basis for priority;
- (c) all reissues, reexaminations, extensions, continuations, continuations in part, continuing prosecution applications, requests for continuing examinations, divisions, registrations of any item in any of the foregoing categories (a) and (b);
- (d) all foreign patents, patent applications, and counterparts of any of the foregoing categories (a) through (c), including, without limitation, certificates of invention, utility models, industrial design protection, design patent protection, and other governmental grants or issuances;
- (e) all items in any of the foregoing in categories (b) through (d), whether or not expressly listed as Patents below and whether or not claims in any of the foregoing have been rejected, withdrawn, cancelled, or the like;
- (f) all inventions, invention disclosures, and discoveries described in any item in any of the foregoing categories (a) through (e) and all other rights arising out of such inventions, invention disclosures, and discoveries;
- (g) all rights to apply in any or all countries of the world for patents, certificates of invention, utility models, industrial design protections, design patent protections, or other governmental grants or issuances of any type related to any item in any of the foregoing categories (a) through (f), including, without limitation, under the Paris Convention for the Protection of Industrial Property, the International Patent Cooperation Treaty, or any other convention, treaty, agreement, or understanding;
- (h) all causes of action (whether known or unknown or whether currently pending, filed, or otherwise) and other enforcement rights under, or on account of, any of the Patents and/or any item in any of the foregoing categories (b) through (g), including, without limitation, all causes of action and other enforcement rights for
- (i) damages,

(ii) injunctive relief, and

(iii) any other remedies of any kind

for past, current, and future infringement; and

(i) all rights to collect royalties and other payments under or on account of any of the Patents and/or any item in any of the foregoing categories (b) through (h).

Patent or Application No.	Country	Filing Date	Title of Patent and First Named Inventor
9,988,201B	U.S.	02/03/2017	Micro-Structured Surface with improved insulation and condensation resistance Neil Edward Darin
2017214665	Australia		Micro-Structured Surface with improved insulation and condensation resistance
112018015870-4	Brazil		Micro-Structured Surface with improved insulation and condensation resistance
3013620	Canada		Micro-Structured Surface with improved insulation and condensation resistance
CN108778681A	China		Micro-Structured Surface with improved insulation and condensation resistance
P2018-178	Dominican Republic		Micro-Structured Surface with improved insulation and condensation resistance
201847033042	India		Micro-Structured Surface with improved insulation and condensation resistance
IDP000077246	Indonesia		Micro-Structured Surface with improved insulation and condensation resistance
10-2168460	Republic of Korea		Micro-Structured Surface with improved insulation and condensation resistance
MX/a/2018/009463	Mexico		Micro-Structured Surface with improved insulation and condensation resistance
2688736			

1-2018-03566	Russian Federation		Micro-Structured Surface with improved insulation and condensation resistance
HK1263100	Vietnam		Micro-Structured Surface with improved insulation and condensation resistance
	Hong Kong		Micro-Structured Surface with improved insulation and condensation resistance
10,575,667B2	U.S.	05/04/2018	Microstructured packaging surfaces for enhanced grip Ralph Allen Hulseman
10,687,642B2	U.S.	06/23/2017	Microstructured packaging surfaces for enhanced grip Ralph Allen Hulseman
2017288910	Australia		Microstructured packaging surfaces for enhanced grip
BR112018076998-3	Brazil		Microstructured packaging surfaces for enhanced grip
3,028,981	Canada		Microstructured packaging surfaces for enhanced grip
201947002755	India		Microstructured packaging surfaces for enhanced grip
2017800393286	China		Microstructured packaging surfaces for enhanced grip
17820980.5	European Patent Office		Microstructured packaging surfaces for enhanced grip
7004680	Japan		Microstructured packaging surfaces for enhanced grip
MX/a/2018/015968	Mexico		Microstructured packaging surfaces for enhanced grip
10-2018-7037106	Republic of Korea		Microstructured packaging surfaces for enhanced grip

1-2019-00112	Vietnam	Microstructured packaging surfaces for enhanced grip
19128031.2	Hong Kong	Microstructured packaging surfaces for enhanced grip
10,752,415B2	US	04/06/2017 Fluid pouch with inner microstructure Neil Darin
2017248301	Australia	Fluid pouch with inner microstructure
112018070338-9	Brazil	Fluid pouch with inner microstructure
3,018,786	Canada	Fluid pouch with inner microstructure
P2018-0221	Dominican Republic	Fluid pouch with inner microstructure
3439611	European Patent Office	Fluid pouch with inner microstructure
602017039325.8	Germany	Fluid pouch with inner microstructure
3439611	France	Fluid pouch with inner microstructure
3439611	United Kingdom	Fluid pouch with inner microstructure
201847040462	India	Fluid pouch with inner microstructure
IDP000076991	Indonesia	Fluid pouch with inner microstructure
10-2431069	Republic of Korea	Fluid pouch with inner microstructure
MX/a/2018/012173	Mexico	Fluid pouch with inner microstructure
1-2018-04649	Vietnam	A flexible container for holding fluid, a method of draining fluid from the container and a method of manufacturing a fluid
2018135621	Russian Federation	Fluid pouch with inner microstructure
19128911.5	Hong Kong	Fluid pouch with inner microstructure

Assignor represents, warrants and covenants that:

(1) Assignor has the full power and authority, and has obtained all third party consents, approvals and/or other authorizations required to enter into this Agreement and to carry out its obligations hereunder, including the assignment of the Patent Rights to Assignee; and

(2) Assignor owns, and by this document assigns to Assignee, all right, title, and interest to the Patent Rights, including, without limitation, all right, title, and interest to sue for infringement of the Patent Rights. Assignor has obtained and properly recorded previously executed assignments for the Patent Rights with the United States Patent and Trademark Office.

Assignor hereby authorizes the respective patent office or governmental agency in each jurisdiction to issue any and all patents, certificates of invention, utility models or other governmental grants or issuances that may be granted upon any of the Patent Rights in the name of Assignee, as the assignee to the entire interest therein.

Assignor will, at the reasonable request of Assignee and without demanding any further consideration therefor, do all things necessary, proper, or advisable, including without limitation, the execution, acknowledgment, and recordation of specific assignments, oaths, declarations, and other documents on a country-by-country basis, to assist Assignee in obtaining, perfecting, sustaining, and/or enforcing the Patent Rights. Such assistance will include providing, prompt production of pertinent facts and documents, giving of testimony, execution of petitions, oaths, powers of attorney, specifications, declarations or other papers, and other assistance reasonably necessary for filing patent applications, complying with any duty of disclosure, and conducting prosecution, reexamination, reissue, interference or other priority proceedings, opposition proceedings, cancellation proceedings, public use proceedings, infringement or other court actions and the like with respect to the Patent Rights.

The terms and conditions of this Assignment of Patent Rights will inure to the benefit of Assignee, its successors, assigns, and other legal representatives and will be binding upon Assignor, its successors, assigns, and other legal representatives.

[Signatures to Follow]

IN WITNESS WHEREOF this Assignment of Patent Rights is executed at
on December 13, 2022

ASSIGNOR:

Havi Global Solutions, LLC

By: Stephen C. Thott
Name: Stephen C. Thott
Title: VP of Finance
(Signature MUST be notarized)

STATE OF ILLINOIS)

) ss.

COUNTY OF WILL)

On December 13, 2022 before me, Tammy R. Segatto Notary
Public in and for said State, personally appeared Stephen C. Thott
personally known to me (or proved to me on the basis of satisfactory evidence) to be
the person whose name is subscribed to the within instrument and acknowledged to me
that he/she executed the same in his/her authorized capacity, and that by his/her
signature on the instrument the person, or the entity upon behalf of which the person
acted, executed the instrument.

WITNESS my hand and official seal.

Signature Tammy R. Segatto

My Commission Expires: November 8, 2026

